PRODUCT DATA SHEET

CORE 92 No-Clean

Cored Wire Solder

Introduction

CORE 92 No-Clean Cored Wire Solder is manufactured to demanding quality standards. It is an excellent complementary product for rework with NC-SMQ92J and Indium5.8LS solder pastes.

Features

- · Halogen-free
- Optimized for use in both SnPb and Pb-free processes
- · Excellent wetting
- · Low smoking

Product Description

Spool Weight	500g or 1lb
Flux Percentage	1.6–2.2% by weight
Available Alloys	Per J-STD-006 Variation C 63Sn/37Pb 62Sn/36Pb/2Ag 96.5Sn/3.0Ag/0.5Cu

Wire Diameters

CORE 92 No-Clean Cored Wire Solder Length per Spool					
Wire Diameter	Sn62	Sn63	96.5Sn/3.0Ag/0.5Cu		
.010" ± .002" (.254mm ± .051mm)	4,695ft (1,431m)	4,691ft (1,429.8m)	1,996ft (608m)		
.015" ± .002" (.381mm ± .051mm)	2,087ft (636m)	2,085ft (635.5m)	2,087ft (636m)		
.020" ± .002" (.508mm ± .051mm)	1,174ft (357.7m)	1,173ft (357.4m)	1,174ft (357.7m)		
.032" ± .002" (.813mm ± .051mm)	459ft (139.8m)	458ft (139.6m)	459ft (139.8m)		

Values are only approximate. Actual lengths will vary.

Bellcore and J-STD Tests and Results

Test	Result	Test	Result	
J-STD-004-A (IPC-TM-650)		Bellcore GR-78		
Flux Type Classification	ROL0	SIR	Pass	
Flux Induced Corrosion (Copper Mirror)	Pass	All information is for reference only. Not to be used as incoming product specifications		
Presence of Halide Fluoride Spot Test	Pass			
Elemental Analysis (Br, Cl, F)	0%			
Corrosion	Pass			
SIR	Pass			

Residue Removal

The flux in **CORE 92** is formulated for use in a no-clean assembly process. If cosmetics or the end use application requires removal of the post reflow residue, standard rosin-based residue removal techniques can be utilized. This includes, but is not limited to; spray-in air, immersion spray, vapor degreasing, or ultrasonic type cleaning processes.

Storage

CORE 92 has a shelf life of 10 years when stored in a dry, non-corrosive environment such as a low humidity dry cabinet. Direct sunlight, excessive humidity, and storage near heat sources should be avoided.

Technical Support

Indium Corporation's internationally experienced engineers provide in-depth technical assistance to our customers. Thoroughly knowledgeable in all facets of Materials Science as it applies to the electronics and semiconductor sectors, Technical Support Engineers provide expert advice in solder properties, alloy compatibility and selection of solder preforms, wire, ribbon, and paste. Indium Corporation's Technical Support Engineers provide rapid response to all technical inquiries.

Safety Data Sheets

Please refer to the SDS document within the product shipment, or contact our local team to receive a copy.

This product data sheet is provided for general information only. It is not intended, and shall not be construed, to warrant or guarantee the performance of the products described which are sold subject exclusively to written warranties and limitations thereon included in product packaging and invoices. All Indium Corporation's products and solutions are designed to be commercially available unless specifically stated otherwise.

All of Indium Corporation's solder paste and preform manufacturing facilities are IATF 16949:2016 certified. Indium Corporation is an ISO 9001:2015 registered company.

From One Engineer To Another

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